

(12) INTERNATIONAL APPLICATION PUBLISHED UNDER THE PATENT COOPERATION TREATY (PCT)

(19) World Intellectual Property
Organization
International Bureau

(43) International Publication Date
23 July 2020 (23.07.2020)



(10) International Publication Number
WO 2020/149796 A1

(51) International Patent Classification:

H01B 7/06 (2006.01) **H01B 13/008** (2006.01)
H01B 1/22 (2006.01)

(21) International Application Number:

PCT/SG2020/050023

(22) International Filing Date:

16 January 2020 (16.01.2020)

(25) Filing Language:

English

(26) Publication Language:

English

(30) Priority Data:

10201900416P 16 January 2019 (16.01.2019) SG

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(81) Designated States (unless otherwise indicated, for every kind of national protection available):

AE, AG, AL, AM, AO, AT, AU, AZ, BA, BB, BG, BH, BN, BR, BW, BY, BZ, CA, CH, CL, CN, CO, CR, CU, CZ, DE, DJ, DK, DM, DO, DZ, EC, EE, EG, ES, FI, GB, GD, GE, GH, GM, GT, HN, HR, HU, ID, IL, IN, IR, IS, JO, JP, KE, KG, KH, KN, KP, KR, KW, KZ, LA, LC, LK, LR, LS, LU, LY, MA, MD, ME, MG, MK, MN, MW, MX, MY, MZ, NA, NG, NI, NO, NZ, OM, PA, PE, PG, PH, PL, PT, QA, RO, RS, RU, RW, SA, SC, SD, SE, SG, SK, SL, ST, SV, SY, TH, TJ, TM, TN, TR, TT, TZ, UA, UG, US, UZ, VC, VN, WS, ZA, ZM, ZW.

(84) Designated States (unless otherwise indicated, for every kind of regional protection available):

ARIPO (BW, GH, GM, KE, LR, LS, MW, MZ, NA, RW, SD, SL, ST, SZ, TZ, UG, ZM, ZW), Eurasian (AM, AZ, BY, KG, KZ, RU, TJ, TM), European (AL, AT, BE, BG, CH, CY, CZ, DE, DK, EE, ES, FI, FR, GB, GR, HR, HU, IE, IS, IT, LT, LU, LV, MC, MK, MT, NL, NO, PL, PT, RO, RS, SE, SI, SK, SM, TR), OAPI (BF, BJ, CF, CG, CI, CM, GA, GN, GQ, GW, KM, ML, MR, NE, SN, TD, TG).

Published:

- with international search report (Art. 21(3))
- in black and white; the international application as filed contained color or greyscale and is available for download from PATENTSCOPE

(54) Title: A STRETCHABLE INTERCONNECT STRUCTURE AND METHOD OF FABRICATING THE SAME

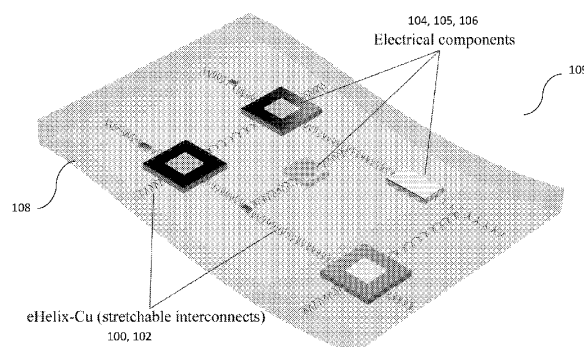


Figure 1(a)

(57) Abstract: A stretchable interconnect structure for electrically connecting electronic devices and a method of fabricating a stretchable interconnect structure for electrically connecting electronic devices. The method comprises the steps of providing an electrically conductive wire having a 3-dimensional helical form; and embedding the electrically conductive wire in a substrate made from an elastic material.



WO 2020/149796 A1